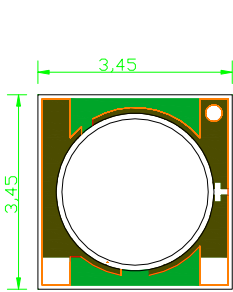


**RF-RUXC35-A SERIES**

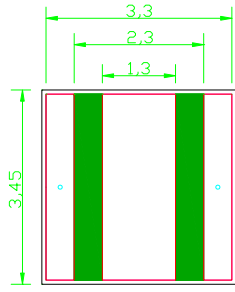
**Description**

- ◆ Viewing angle:120 deg
- ◆ The materials of the LED dice is AlInGaP
- ◆ 3.45mm×3.45mm×1.95mm power-LED
- ◆ RoHS compliant lead-free soldering compatible

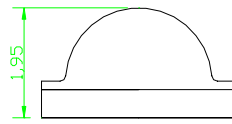
**Package Outline**



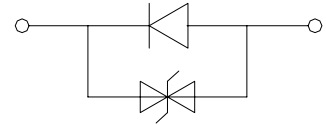
top view




bottom view



side view





**ATTENTION**  
OBSERVE PRECAUTIONS  
FOR HANDLING  
ELECTROSTATIC  
SENSITIVE DEVICES

**NOTES:**

1. All dimensions are in millimeters (inches);
2. Tolerances are ±0.3mm (0.012inch) unless otherwise noted.

### Absolute maximum ratings at Ta=25°C

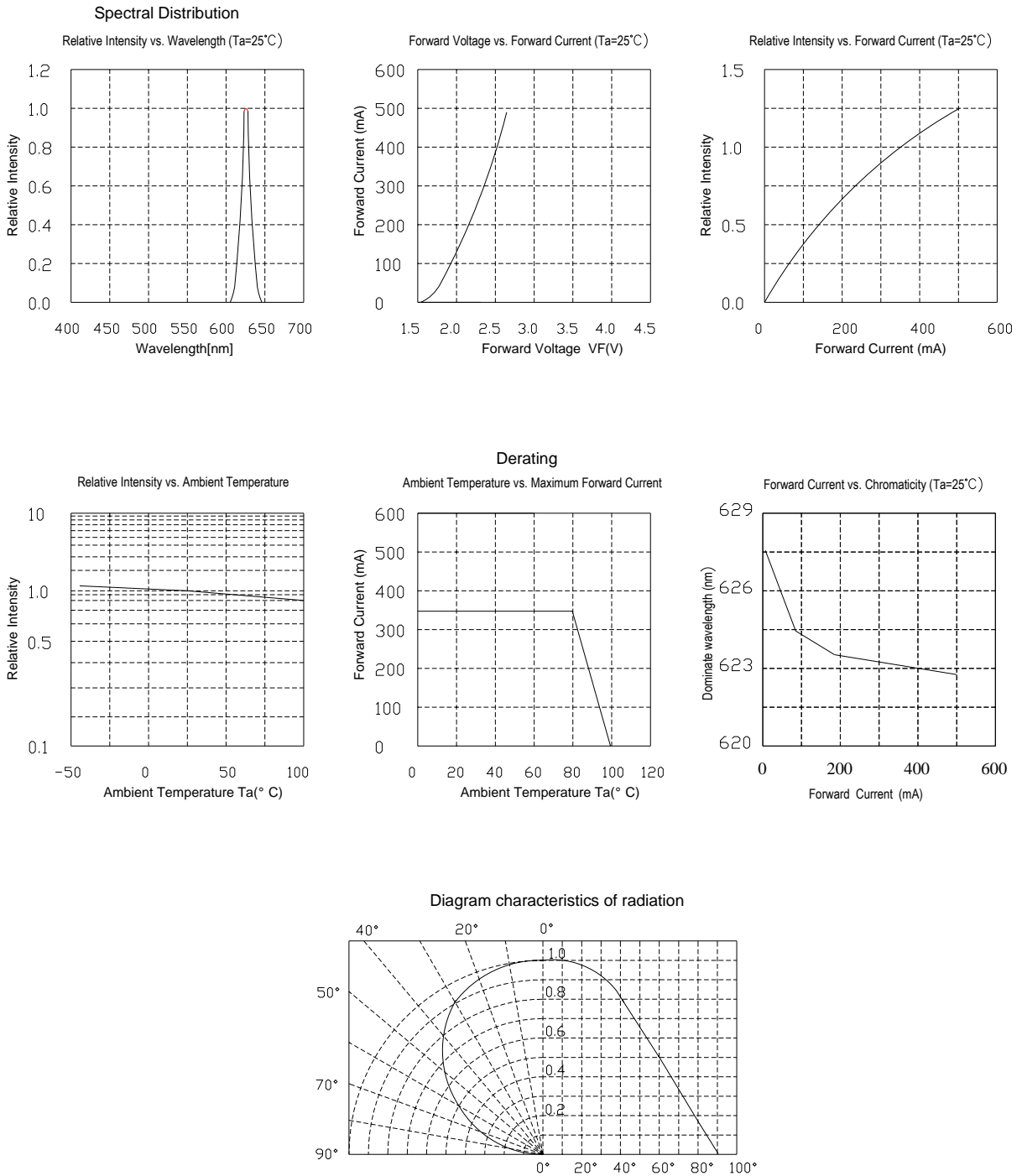
Parameter	Symbol	Value	Unit
Forward DC current	If	350	mA
Reverse DC voltage	Vr	5	V
Operating temperature range	Top	-40~+100	°C
Storage temperature range	Tstg	-40~+100	°C
Peak pulsing current	Ifp	500	mA
ESD Classification	ESD	6000	V
Thermal resistance@350mA	$\theta_{th}$	20	°C/W

### Electro-optical characteristics at Ta=25°C

Parameter	Test Condition	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	If=350mA	Vf	1.8	--	2.8	V
Dominant wavelength	If=350mA	$\lambda_d$	620	--	625	nm
	If=350mA	$\lambda_d$	625	--	630	nm
Luminous flux	If=350mA	$\Phi$	30	--	50	lm
Viewing angle at 50% Iv	If=350mA	2 $\theta_{1/2}$	--	120	--	Deg
Reverse current	Vr=5V	Ir	--	--	10	$\mu$ A

**NOTE:** (Tolerance:  $\emptyset$   $\pm 10\%$ , X/Y  $\pm 0.01$ , Vf  $\pm 0.1V$ )  
 IFP Conditions : Pulse Width  $\leq 10\text{msec.}$  and Duty  $\leq 1/10$ .

## Optical characteristics curves



## Reflow profile

### ■ Soldering condition

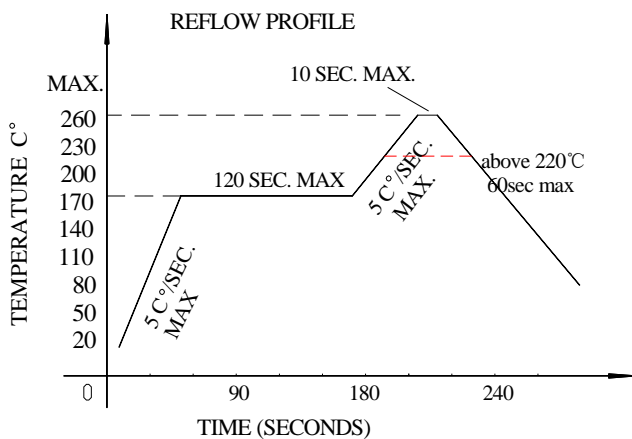
- Recommended soldering conditions

Reflow Soldering		Hand Soldering	
Pre-heat	160~180°C	Temperature	300°C Max.
Pre-heat time	120 seconds Max.	Soldering time	3 second Max. (one time only)
Peak temperature	260°C Max.		
Soldering time	10 seconds Max.		
Condition	Refer to Temperature-profile		

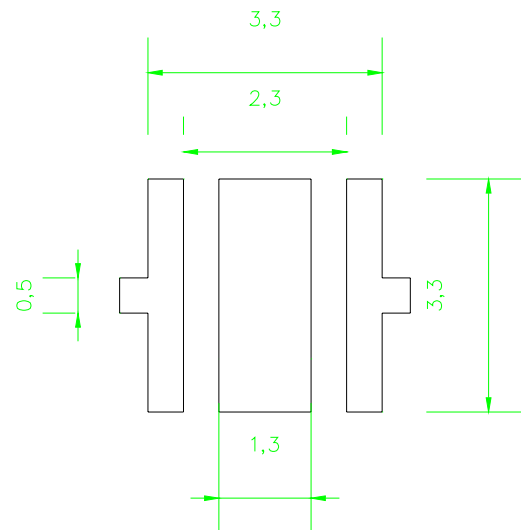
- After reflow soldering rapid cooling should be avoided

### ■ Temperature-profile (Surface of circuit board)

Use the following conditions shown in the figure.



### RECOMMEND PAD DESIGN (Units: mm)



1. Reflow soldering should not be done more than two times
2. When soldering, do not put stress on the LEDs during heating

### ■ Soldering iron

1. When hand soldering, keep the temperature of the iron under 300°C, and at that temperature keep the time under 3 sec.
2. The hand soldering should be done only a time
3. The basic spec is  $\leq 5$  sec. when the temperature of 260°C, do not contact the resin when hand soldering



Reliability

(1)TEST ITEMS AND RESULTS

Type	Test Item	Ref. Standard	Test Conditions	Note	Number of Damaged
Environmental Sequence	Resistance to Soldering Heat(Reflow Soldering)	JESD22-B106	Tsld=260°C,10sec	3 times	0/22
	Temperature Cycle	JESD22-A104	-40°C 30min ↑↓5min 100°C 30min	200 cycle	0/22
	Thermal Shock	JESD22-A106	-40°C 15min ↑↓ 100°C 15min	200 cycle	0/22
	High Temperature Storage	JESD22-A103	T <sub>a</sub> =100°C	1000 hrs	0/22
	Low Temperature Storage	JESD22-A119	T <sub>a</sub> =-40°C	1000 hrs	0/22
Operation Sequence	Life Test	JESD22-A108	T <sub>a</sub> =25°C I <sub>F</sub> =700mA	1000 hrs	0/22
	High Temperature Life Test	JESD22-A108	T <sub>a</sub> =85°C I <sub>F</sub> =350mA	1000 hrs	0/22
	High Humidity Heat Life Test	JESD22-A101	60°C RH=90% I <sub>F</sub> =350mA	1000 hrs	0/22

(2)CRITERIA FOR JUDGING THE DAMAGE

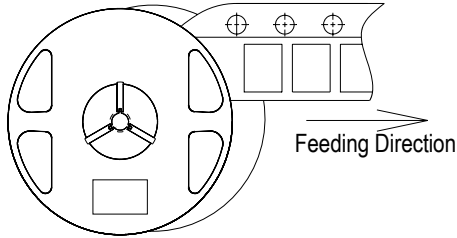
Item	Symbol	Test Conditions	Criteria for Judgement	
			Min.	Max.
Forward Voltage	VF	IF=350mA	-	U.S.L*)×1.1
Reverse Current	IR	VR=5V	-	U.S.L*)×2.0
Luminous flux	Φ	IF=350mA	L.S.L**)×0.7	-

U.S.L.: Upper Standard Level

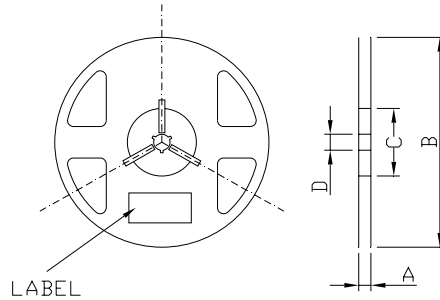
L.S.L.: Lower Standard Level

## Packaging Specifications

### ● Feeding Direction

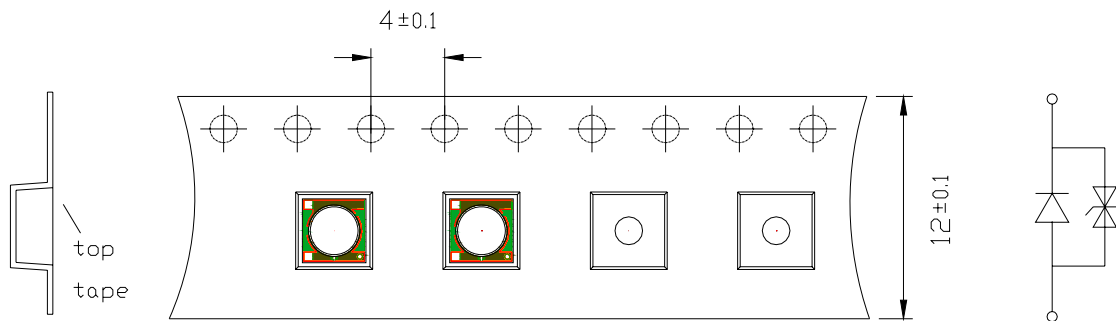


### ● Dimensions of Reel (Unit: mm)

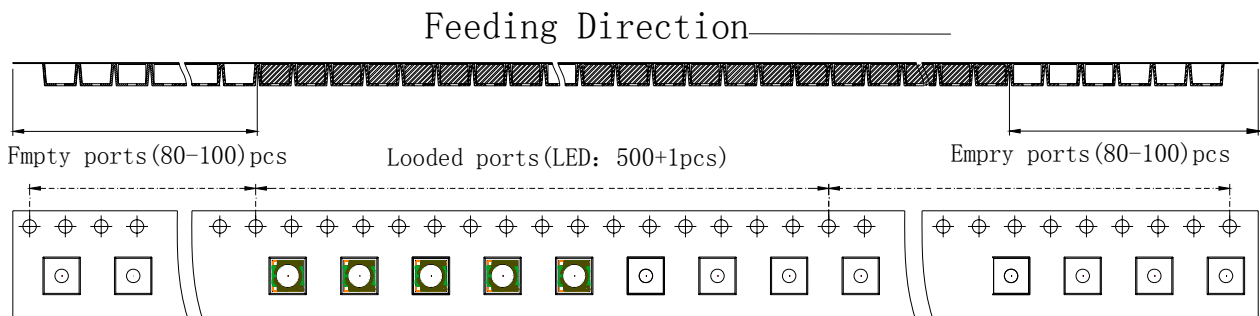


A	12.4±0.1mm
B	330±1mm
C	100±1mm
D	13.0±0.5mm

### ● Dimensions of Tape (Unit: mm)



### ● Arrangement of Tape

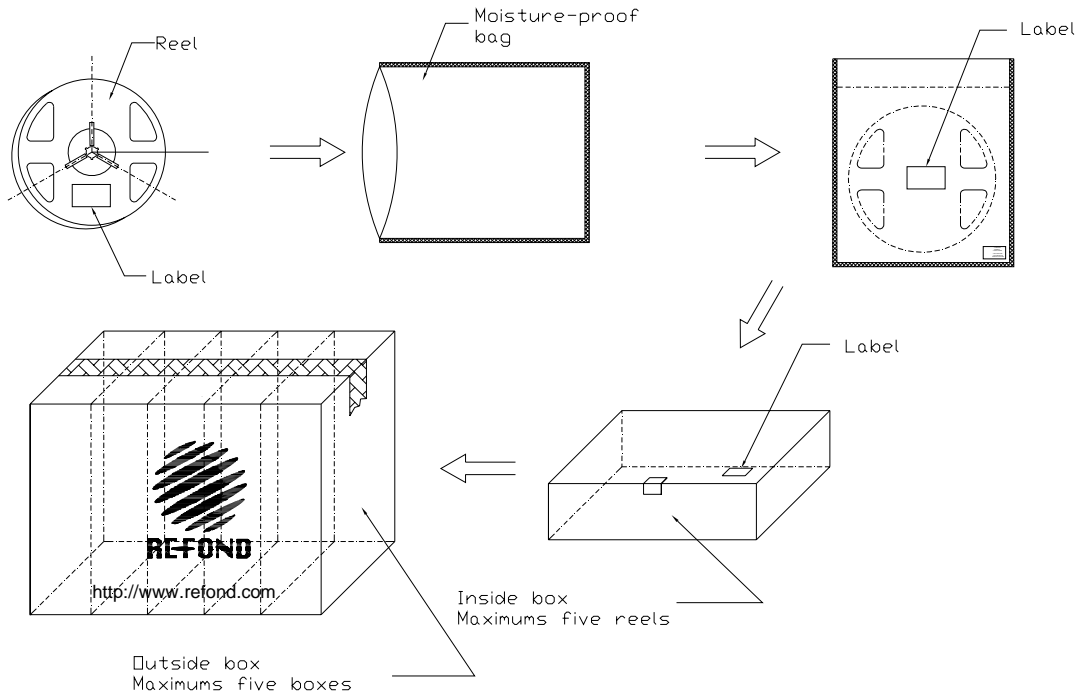


## NOTES

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing lamps is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
4. 500 pcs/ Reel.



# Packaging specifications



### Label

<b>PART NO.</b>	
<b>LOT NO.</b>	
<b>BIN CODE:</b>	
	<b>QTY: PCS</b>
	<b>DATE:</b>

## CAUTIONS

### Package specifications

Reeled products (numbers of products are 500pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Five moisture-proof bag of maximums (total maximum number of products are 2,500pcs) packed in an inside box (size: about 350mm x about 350 x about 165mm), and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.)

### Storage conditions

#### Before opening the package:

The LEDs should be kept at 30°C or less and 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.

#### After opening the package:

The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.